

## Description

The NTD3055-150 uses advanced trench

technology to provide excellent RDS(ON), low gate

charge and operation with gate voltages as low

as 4.5V. This device is suitable for use as a

Battery protection or in other Switching application.

## **General Features**

V<sub>DS</sub> = 60V I<sub>D</sub> =20 A

 $R_{DS(ON)} < 32m\Omega @ V_{GS}=10V$ 

## Application

Battery protection

Load switch

Uninterruptible power supply

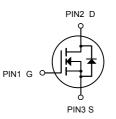
## Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
NTD3055-150	TO-252-2L	HXY MOSFET	2500

## Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	Drain-Source Voltage 60	
Vgs	Gate-Source Voltage	±20	V
I₀@Tc=25°C	Continuous Drain Current, VGS @ 10V1	20	A
I <b>⊳@T</b> c=100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	10	А
Ідм	Pulsed Drain Current <sup>2</sup>	80	А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	38	mJ
P₀@Tc=25°C	Total Power Dissipation <sup>4</sup>	34.7	W
Тѕтс	TstgStorage Temperature RangeTJOperating Junction Temperature Range		°C
TJ			°C





N-Channel MOSFET

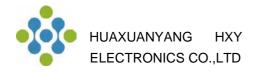


# **Electrical Characteristics (TJ = 25°C, unless otherwise noted)**

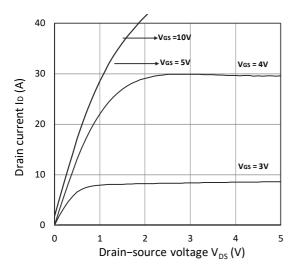
Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static Characteristics		1	1		1	1		
Drain-Source Breakdown Voltage		V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	60	-	-	V	
Gate-Body Leakage Current		<b>Igss</b> V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V		-	-	±100	nA	
Zero Gate Voltage Drain	TJ=25℃	ldss		-	-	1	μA	
Current	TJ=100℃		$V_{DS} = 60V, V_{GS} = 0V$	-	-	100		
Gate-Threshold Voltage			1.2	1.7	2.5	V		
			V <sub>GS</sub> = 10V, I <sub>D</sub> = 10A	-	25	32		
Drain-Source on-Resistance	<u>j</u> 4	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 5A	-	31.5	40	- mΩ	
Forward Transconductance	1	<b>g</b> fs	V <sub>DS</sub> = 5V, I <sub>D</sub> = 10A	-	15.5	-	S	
Dynamic Characteristic	<b>S</b> <sup>5</sup>				L			
Input Capacitance		Ciss		-	1355	-		
Output Capacitance		C <sub>oss</sub>	V <sub>DS</sub> = 30V, V <sub>GS</sub> =0V, f =1MHz	-	60	-	pF	
Reverse Transfer Capacitar	се	Crss		-	49	-		
Gate Resistance		Rg	f =1MHz	-	1.2	-	Ω	
Switching Characteristi	CS <sup>5</sup>	·					•	
Total Gate Charge		Qg		-	22	-		
Gate-Source Charge		Qgs	V <sub>GS</sub> = 10V, V <sub>DD</sub> = 30V, I <sub>D</sub> = 10A	-	4.2	-	nC	
Gate-Drain Charge		Q <sub>gd</sub>		-	6.9	-		
Turn-on Delay Time		t <sub>d(on)</sub>		-	6.4	-		
Rise Time		tr	V <sub>GS</sub> =10V, V <sub>DD</sub> = 30V,	-	15.3	-	ns	
Turn-off Delay Time		t <sub>d(off)</sub>	$R_G = 3\Omega$ , $I_D = 10A$	-	25	-		
Fall Time		tr	-	-	7.6	-		
Body Diode Reverse Recovery Time		trr		-	26	-	ns	
Body Diode Reverse Recovery Charge		Qrr	l⊧=10A, dl⊧/dt=100A/µs	-	45	-	nC	
Drain-Source Body Dio	de Characte	ristics	1	<b>I</b>	L	1	1	
Diode Forward Voltage <sup>4</sup>		Vsd	I <sub>S</sub> = 10A, V <sub>GS</sub> = 0V	-	-	1.2	V	
Continuous Source Current	Tc=25℃	ls	_		_	20	A	

Notes:

- 1. Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})}\text{=}150^\circ\text{C}$
- 2. The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}\text{=}25V,\,V_{\text{GS}}\text{=}10V,\,L\text{=}0.4\text{mH},\,I_{\text{AS}}\text{=}14\text{A}$
- 3. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
- 4. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.
- 5. This value is guaranteed by design hence it is not included in the production test.



# **Typical Characteristics**





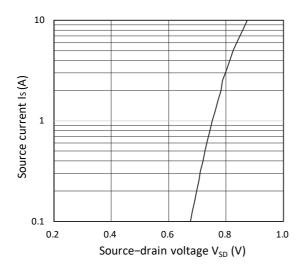


Figure 3. Forward Characteristics of Reverse

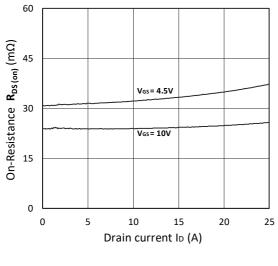


Figure 5.  $R_{\text{DS}(\text{ON})}$  vs.  $I_{\text{D}}$ 

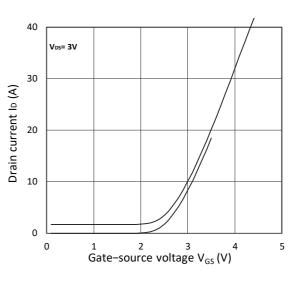
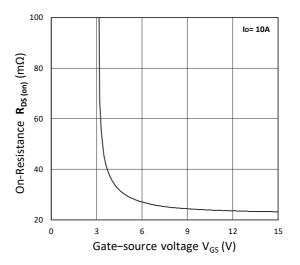


Figure 2. Transfer Characteristics





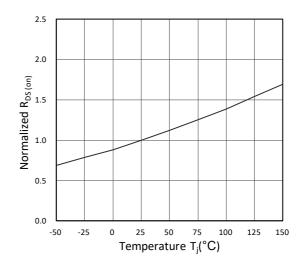
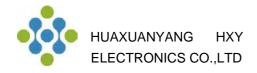
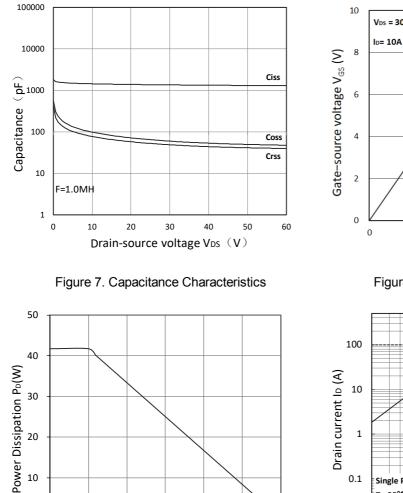
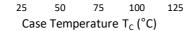


Figure 6. Normalized  $R_{DS(on)}$  vs. Temperature



# NTD3055-150 N-Channel Enhancement Mode MOSFET





20

10

0

0



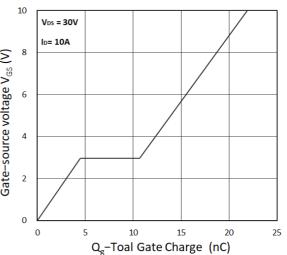
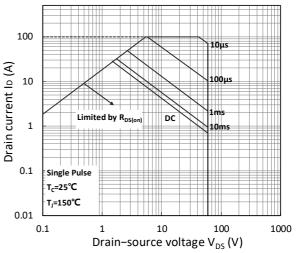
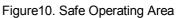
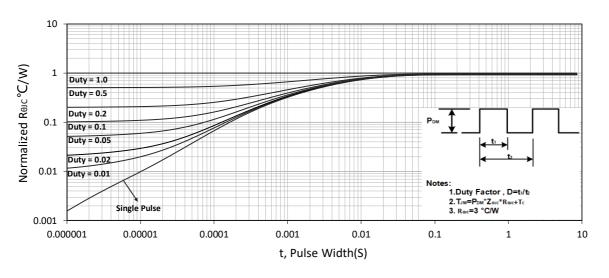


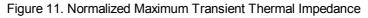
Figure 8. Gate Charge Characteristics





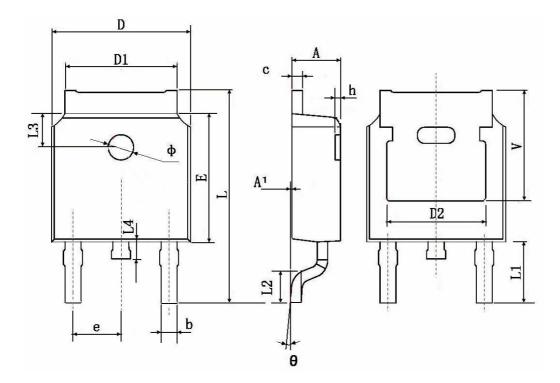


150





# **TO-252-2L Package Information**



Ourseland	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	0.483	TYP.	0.19	0.190 TYP.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0 °	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211 TYP.		



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